

RC1616

0.5A Adjustable/Fixed Low Dropout Linear Regulator

Features

- Low dropout voltage
- Load regulation: 0.05% typical
- Current limit
- On-chip thermal limiting
- Standard SOT-223 and TO-252 packages
- Three-terminal adjustable or fixed 2.5V, 3.3V or 5V

Applications

- USB Controlled Power Supply
- High efficiency linear regulators for Mixed Voltage Logic, ASIC, FPGA based systems
- Post regulators for switching supplies
- Battery chargers
- 5V to 3.3V, or 2.5V, 1.8V, 1.5V linear regulators
- Motherboard clock supplies
- SDRAM Module supplies

Description

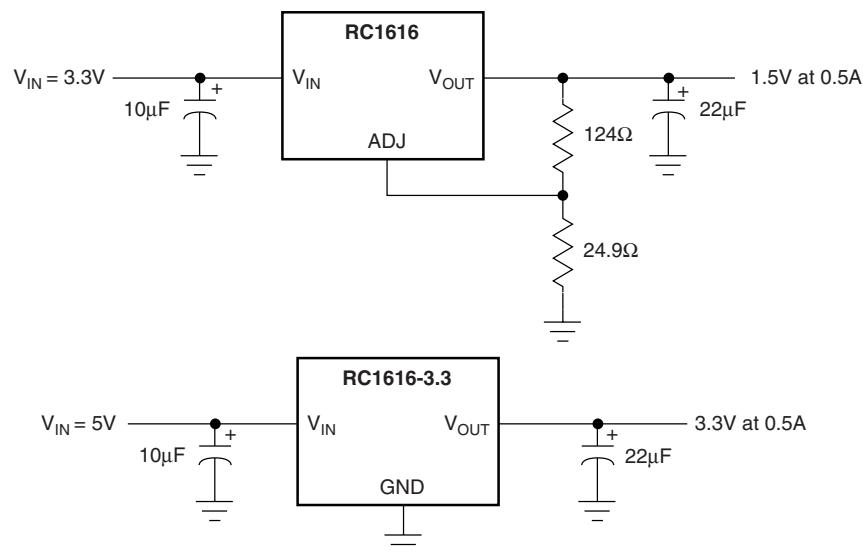
The RC1616 and RC1616-2.5, -3.3 and -5 are low dropout three-terminal regulators with 0.5A output current capability. These devices have been optimized for low voltage where transient response and minimum input voltage are critical. The 5V version is designed also to be used in USB Hub and Motherboard applications.

On-chip thermal limiting provides protection against any combination of overload and ambient temperature that would create excessive junction temperatures.

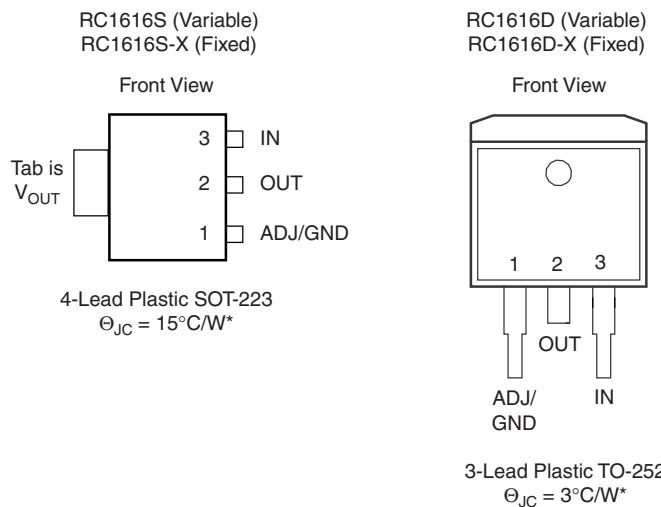
Unlike PNP type regulators where up to 10% of the output current is wasted as quiescent current, the bias current of the RC1616 flows into the load, increasing efficiency.

The RC1616 series regulators are available in the industry-standard SOT-223 and TO-252 power packages.

Typical Applications



Pin Assignments



*With package soldered to 0.5 square inch copper area over backside ground plane or internal power plane, Θ_{JA} can vary from 30°C/W to >50°C/W. Other mounting techniques may provide better power dissipation than 30°C/W.

Absolute Maximum Ratings

Parameter	Min.	Max.	Unit
V_{IN}		7.5	V
Operating Junction Temperature Range	0	125	°C
Storage Temperature Range	-65	150	°C
Lead Temperature (Soldering, 10 sec.)		300	°C

Electrical Characteristics

Operating Conditions: $V_{IN} \leq 7V$, $T_J = 25^\circ C$ unless otherwise specified.

The • denotes specifications which apply over the specified operating temperature range.

Parameter	Conditions	Min.	Typ.	Max.	Units
Reference Voltage ³	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75V$, $10mA \leq I_{OUT} \leq 0.5A$	• 1.225 (-2%)	1.250	1.275 (+2%)	V
Output Voltage	$10mA \leq I_{OUT} \leq 0.5A$ RC1616-2.5, $4.0V \leq V_{IN} \leq 7V$ RC1616-3.3, $4.5V \leq V_{IN} \leq 7V$ RC1616-5, $6.2V \leq V_{IN} \leq 7V$	• 2.450 • 3.234 • 4.900	2.500 3.300 5.000	2.550 3.366 5.100	V
Line Regulation ^{1,2}	$(V_{OUT} + 1.5V) \leq V_{IN} \leq 7V$, $I_{OUT} = 10mA$	•	0.005	0.2	%
Load Regulation ^{1,2,3}	$(V_{IN} - V_{OUT}) = 2V$, $10mA \leq I_{OUT} \leq 0.5A$	•	0.05	0.5	%
Dropout Voltage	$\Delta V_{REF} = 1\%$, $I_{OUT} = 0.5A$	•	1.000	1.200	V
Adjust Pin Current ³		•	35	120	μA
Adjust Pin Current Change ³	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75$, $10mA \leq I_{OUT} \leq 0.5A$	•	0.2	5	μA
Minimum Load Current	$1.5V \leq (V_{IN} - V_{OUT}) \leq 5.75$	• 10			mA
Quiescent Current	$V_{IN} = V_{OUT} + 1.25V$	• 4		13	mA
Ripple Rejection	$f = 120Hz$, $C_{OUT} = 22\mu F$ Tantalum, $(V_{IN} - V_{OUT}) = 3V$, $I_{OUT} = 0.5A$		60 72		dB
Thermal Regulation	$T_A = 25^\circ C$, 30ms pulse		0.004	0.02	%/W
Temperature Stability		• 0.5			%
Long-Term Stability	$T_A = 125^\circ C$, 1000hrs.		0.03	1.0	%
RMS Output Noise (% of V_{OUT})	$T_A = 25^\circ C$, $10Hz \leq f \leq 10kHz$		0.003		%
Thermal Resistance, Junction to Case	SOT-223 TO-252		15 3		$^\circ C/W$
Thermal Shutdown			150		$^\circ C$

Notes:

1. See thermal regulation specifications for changes in output voltage due to heating effects. Load and line regulation are measured at a constant junction temperature by low duty cycle pulse testing.
2. Line and load regulation are guaranteed up to the maximum power dissipation. Power dissipation is determined by input/output differential and the output current. Guaranteed maximum output power will not be available over the full input/output voltage range.
3. RC1616 only.

Typical Performance Characteristics

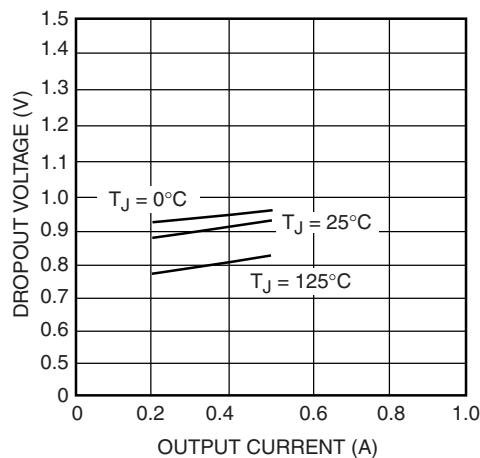


Figure 1. Dropout Voltage vs. Output Current

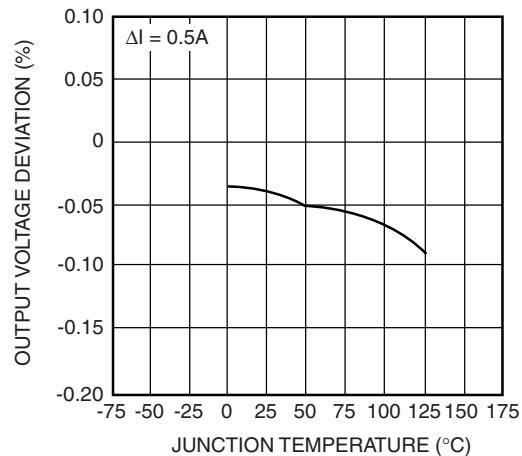


Figure 2. Load Regulation vs. Temperature

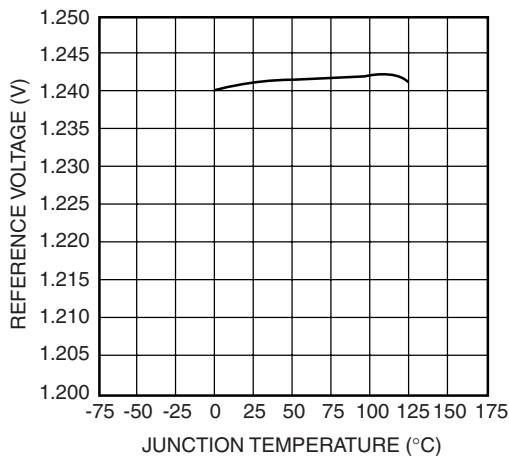


Figure 3. Reference Voltage vs. Temperature

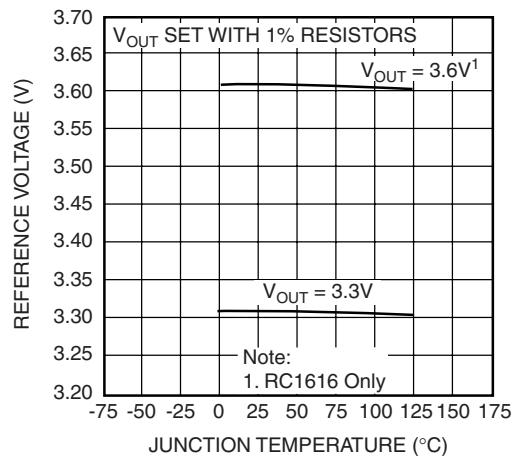


Figure 4. Output Voltage vs. Temperature

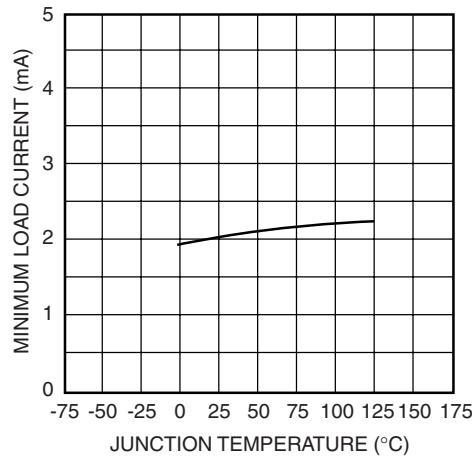


Figure 5. Minimum Load Current vs. Temperature

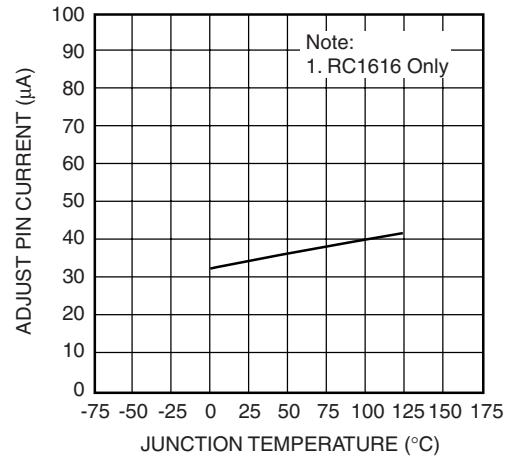


Figure 6. Adjust Pin Current vs. Temperature

Typical Performance Characteristics (continued)

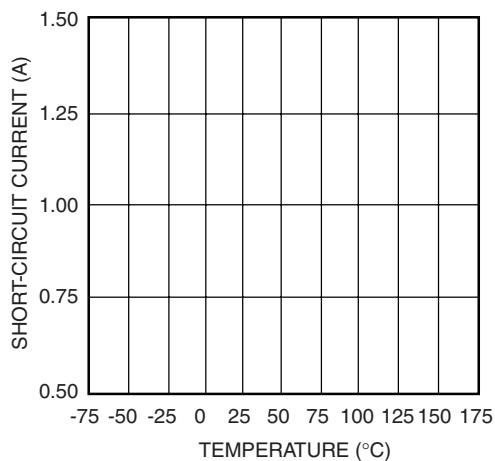


Figure 7. Short-Circuit Current vs. Temperature

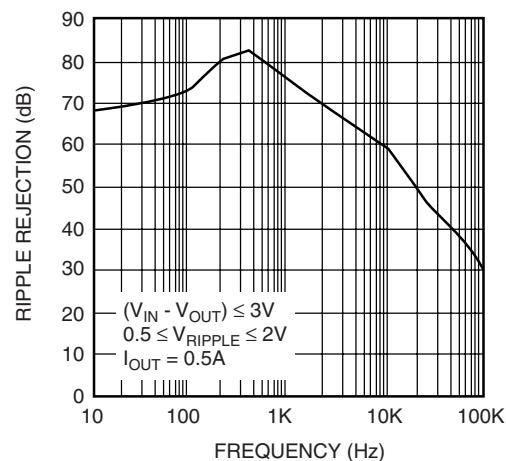


Figure 8. Ripple Rejection vs. Frequency

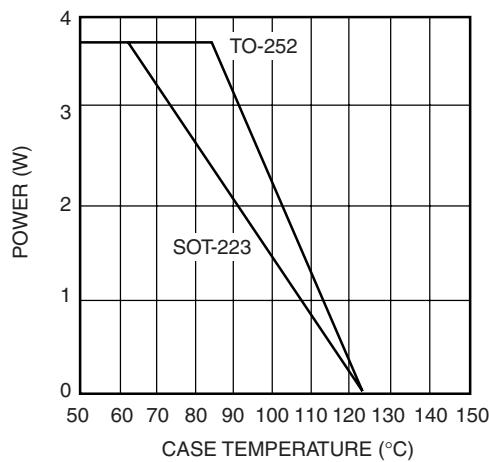


Figure 9. Maximum Power Dissipation

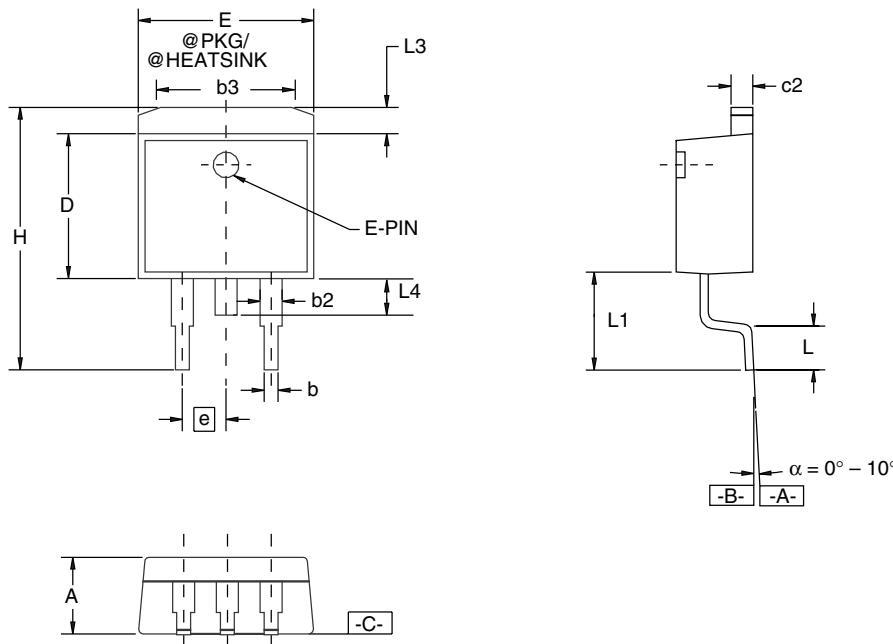
Mechanical Dimensions

3-Lead TO-252 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	.086	.094	2.19	2.39	
b	.025	.035	0.64	0.89	
b2	.030	.045	0.76	1.14	
b3	.205	.215	5.21	5.46	4
c	.018	.024	0.46	0.61	
c2	.018	.023	0.46	0.58	
D	.210	.245	5.33	6.22	1
E	.250	.265	6.35	6.73	1
e	.090 BSC		2.29 BSC		
H	.370	.410	9.40	10.41	
L	.055	.070	1.40	1.78	3
L1	.108 REF		2.74 REF		
L3	.035	.080	0.89	2.03	4
L4	.025	.040	0.64	1.02	

Notes:

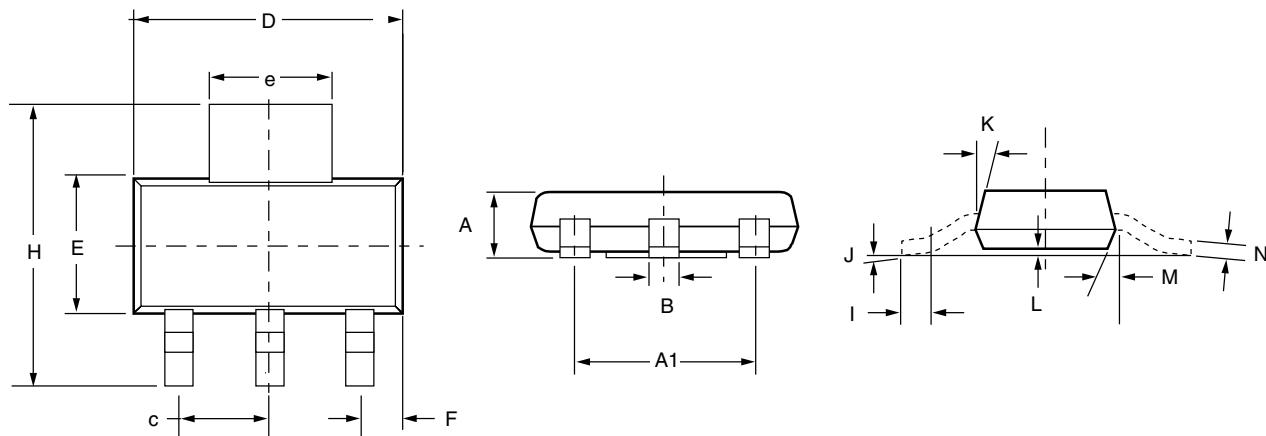
1. Dimensions are exclusive of mold flash, metal burrs or interlead protrusion.
2. Stand off-height is measured from lead tip with ref. to Datum -B-.
3. Foot length is measured with ref. to Datum -A- with lead surface.
4. Thermal pad contour optional within dimension b3 and L3.
5. Formed leads to be planar with respect to one another at seating place -C-.
6. Dimensions and tolerances per ASME Y14.5M-1994.



Mechanical Dimensions

4-Lead SOT-223 Package

Symbol	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	—	.071	—	1.80	
A1	—	.181	—	4.80	
B	.025	.033	.640	.840	
c	—	.090	—	2.29	
D	.248	.264	6.30	6.71	
E	.130	.148	3.30	3.71	
e	.115	.124	2.95	3.15	
F	.033	.041	.840	1.04	
H	.264	.287	6.71	7.29	
I	.012	—	.310	—	
J	—	10°	—	10°	
K	10°	16°	10°	16°	
L	.0008	.0040	.0203	.1018	
M	10°	16°	10°	16°	
N	.010	.014	.250	.360	



Ordering Information

Product Number	Package
RC1616D	TO-252
RC1616S	SOT-223
RC1616D-2.5	TO-252
RC1616S-2.5	SOT-223
RC1616D-3.3	TO-252
RC1616S-3.3	SOT-223
RC1616D-5	TO-252
RC1616S-5	SOT-223

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